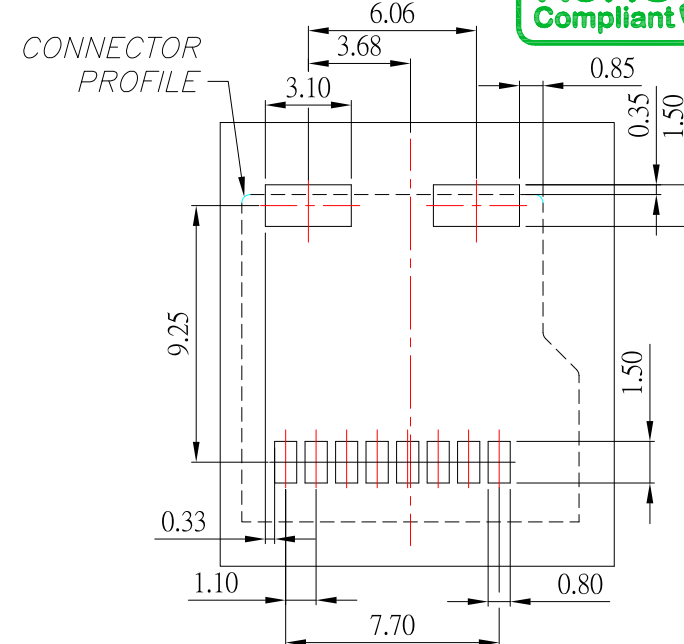
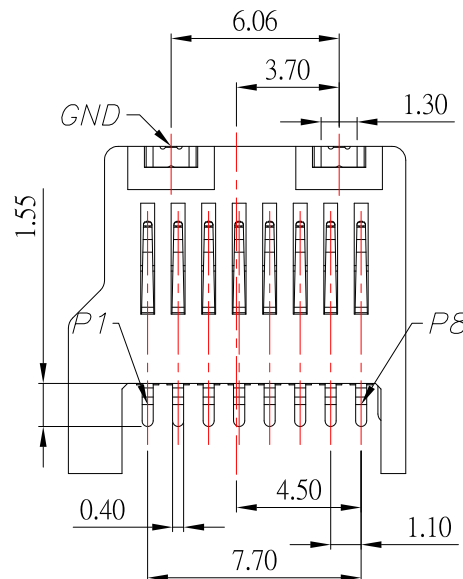
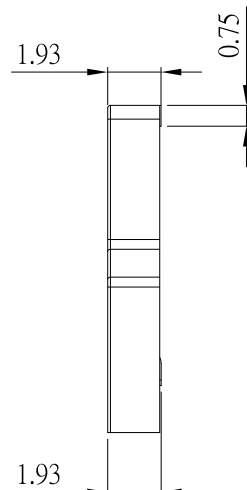
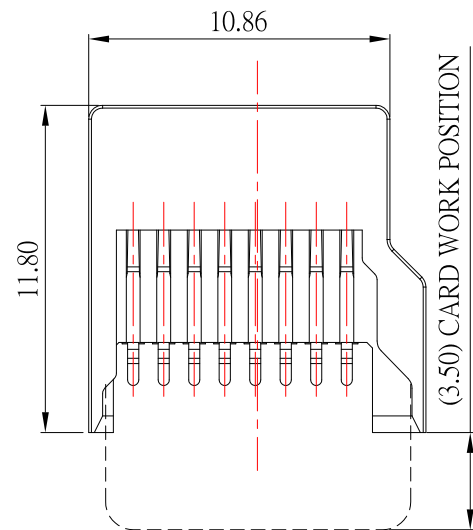




#### SPECIFICATION

##### Electrical :

- 1.Current Rating: 0.5A
- 2.Voltage Rating: 50V
- 3.Contact Resistance: 50 mΩ Max.
- 4.Insulation Resistance: 500 MΩ Min.

##### Environmental:

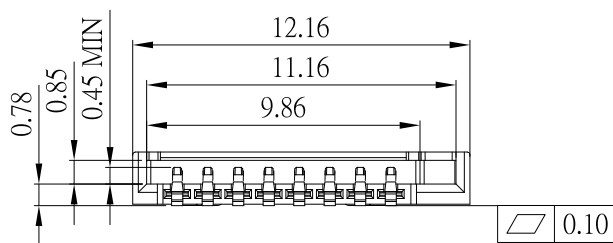
- 1.Operating Temperature: -20°C ~ +60°C.

##### Material:

- 1.Housing: LCP,UL 94V-0
- 2.Contact: Copper Alloy
- 3.Ground: Stainless Steel

##### Finish:

- 1.Contact: Plated Gold in Mating Area ;  
Tin Plated on Solder Balls ;  
Nickel under plated overall
- 2.Ground: Tin Plated on Solder Balls ;  
Nickel under plated overall



| Pin No. | NAME     | TYPE   | DESCRIPTION                 |
|---------|----------|--------|-----------------------------|
| 1       | DAT 2    | I/O/PP | Date Line(bit2)             |
| 2       | CD/DAT 3 | I/O/PP | Card Detect/Date Line(bit3) |
| 3       | CMD      | PP     | Command Response            |
| 4       | VDD      | S      | Supply Voltage              |
| 5       | CLK      | I      | Colck                       |
| 6       | VSS      | S      | Supply Voltage Ground       |
| 7       | DAT0     | I/O/PP | Date Line(bit0)             |
| 8       | DAT1     | I/O/PP | Date Line(bit1)             |

**CONTACT**

建倚科技股份有限公司  
**CONTACT TECHNOLOGY CORP.**

TOLERANCE UNLESS  
OTHERWISE STATED :

Up to 5 ±0.2  
Above 5 ~ 15 ±0.3  
Above 15 ~ 30 ±0.4  
Above 30 ~ 50 ±0.5  
Angle ±0.3°

3RD.  
ANGEL'S



UNITS

MM

DRAWN BY: Jack Lu  
DATE: 11/24/21

CHECKED BY: Jacky Chen  
DATE: 11/24/21

APPROVED BY: Tony Kao  
DATE: 11/24/21

| MATL      | TITLE    | CONNECTOR       |
|-----------|----------|-----------------|
| FINISH    | MODLE    | MICRO SD 卡座全塑   |
| SCALE     | DWG NO.  | SD-TF1308S-S267 |
| SHEET NO. | PART NO. | SD-TF1308S-S267 |

| SIZE |
|------|
| A4   |
| VER  |
| R3   |

| ITEM NO. | DESCRIPTION | DRAWN | DATE   |
|----------|-------------|-------|--------|
| 3        | 更新料號        | Jack  | 112421 |
| 2        | 更新料號        | Jack  | 112321 |
| 1        | 更新尺寸標示      | Jack  | 080218 |